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SCDI for EUV photomask metrology

RESCAN - Reflective EUV Mask Scanning Lensless Imaging Tool

Our Goal

- RESCAN project overview

Background

- 2-step method for defect inspection
- short introduction to Ptychography & scattering contrast microscopy
- experimental setup

Results

- reconstructed sample mask

Future

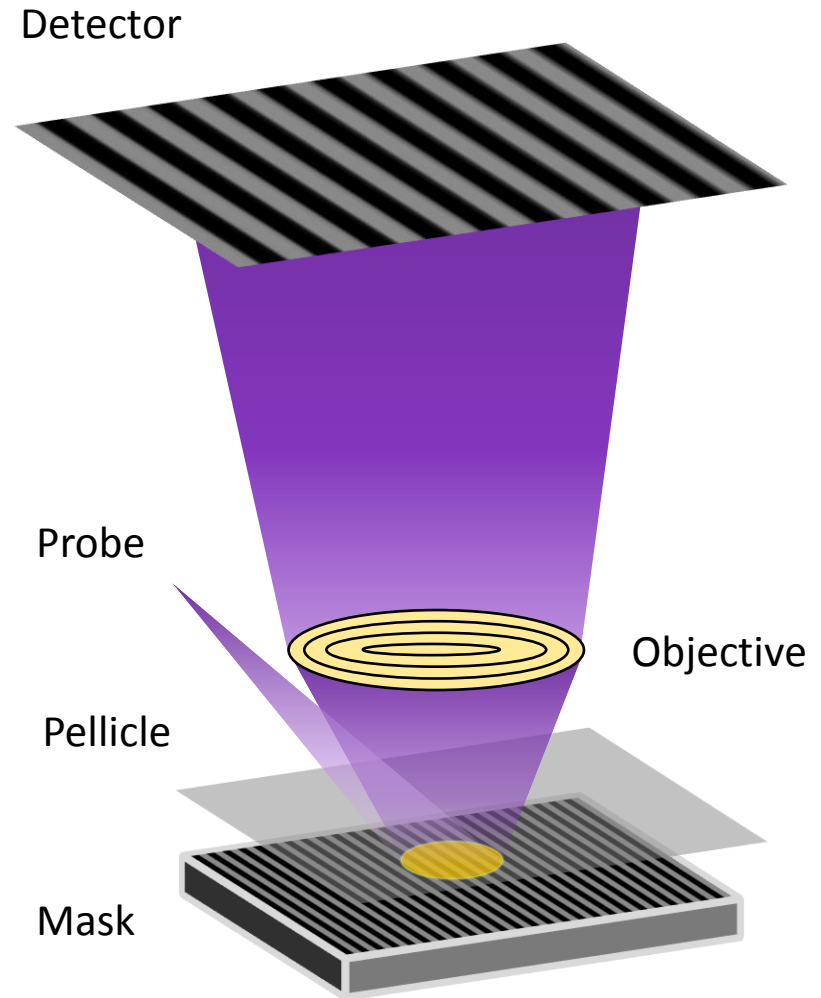
- outlook & conclusions

RESCAN: Project Overview

- **Goal**
 - develop scanning coherent lens-less imaging methods
 - algorithms and instrumentation
 - provide EUV metrology in reflection mode
 - provide method for actinic pattern inspection of EUV reticles
 - reach a resolution of 38 nm with high throughput and sensitivity
- **Research Plan**
 - implement mask defect inspection (at 6° incidence angle) at the Swiss Light Source (SLS)
 - maximize performance in terms of resolution and throughput
 - develop stand-alone prototype for mask defect inspection

Mask Inspection in Real Space

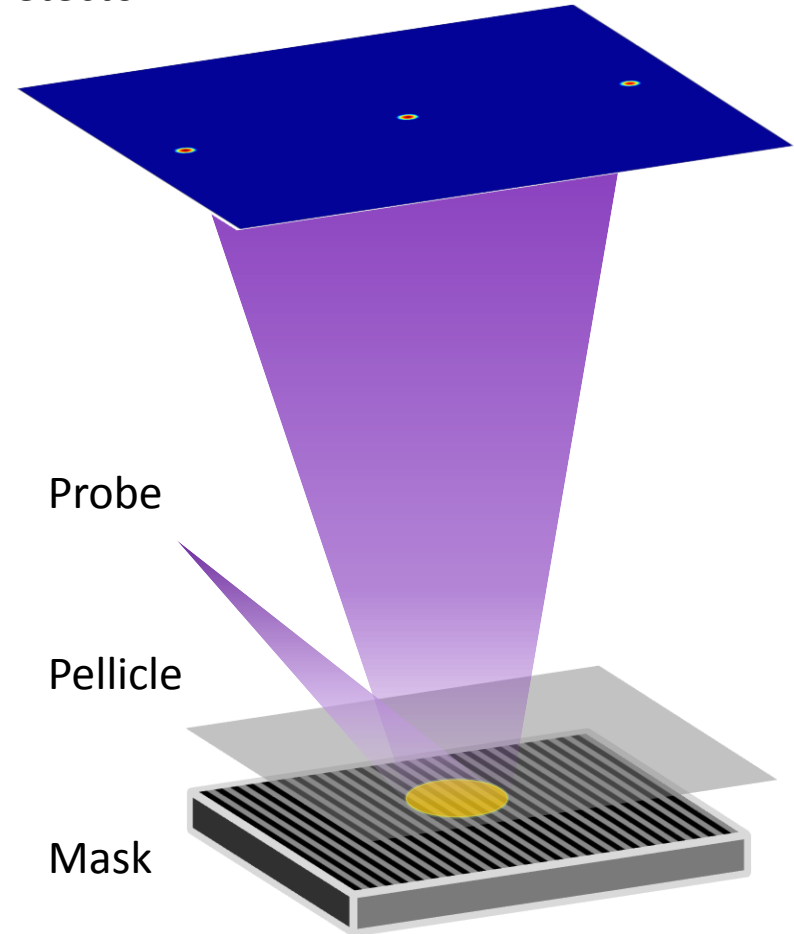
- output is easy to interpret
- resolution is limited by optics
- limited depth of focus
- needs expensive optics



Mask Inspection in Fourier Space

- resolution is defined by detector size
- large depth of focus
- output is hard to interpret and needs complex algorithms
- easy setup due to absence of objective lens

Detector



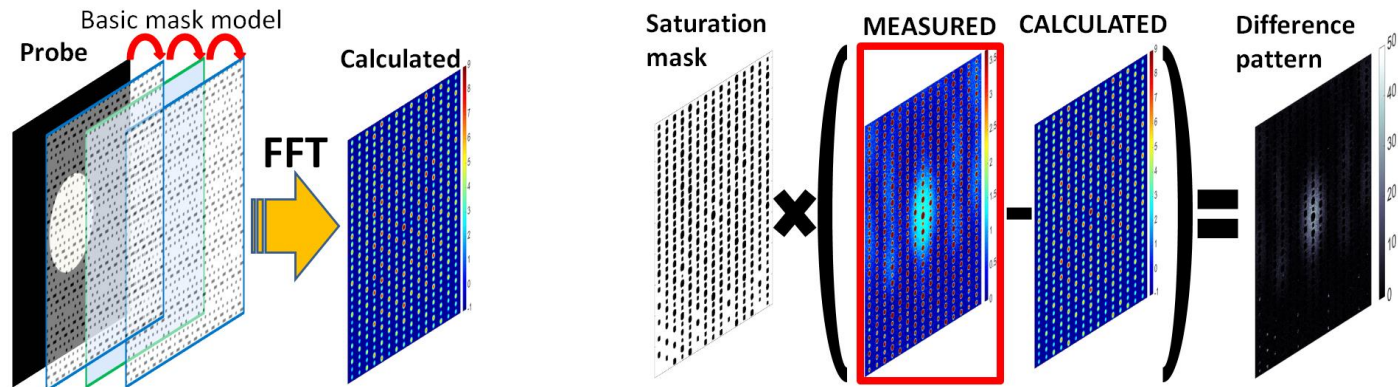
Probe

Pellicle

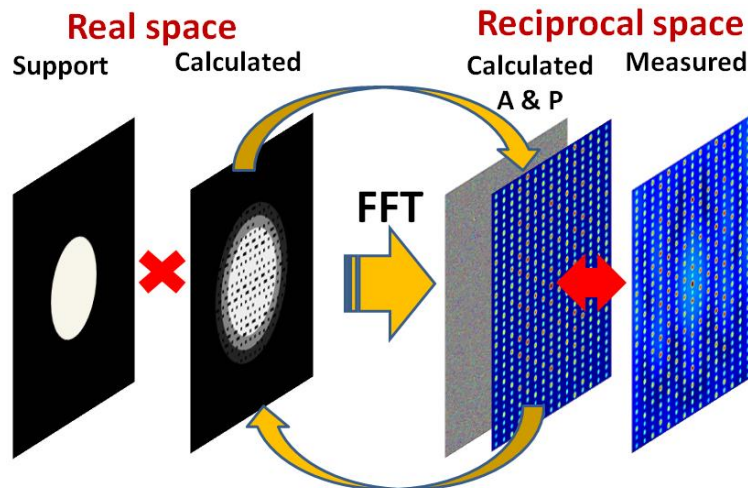
Mask

RESCAN: a 2-Step Approach

- **Idea**
 - combine real space and Fourier space inspection into a 2-step method
 - rough inspection with Scanning Scattering Contrast Microscopy to locate defects

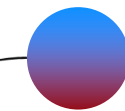
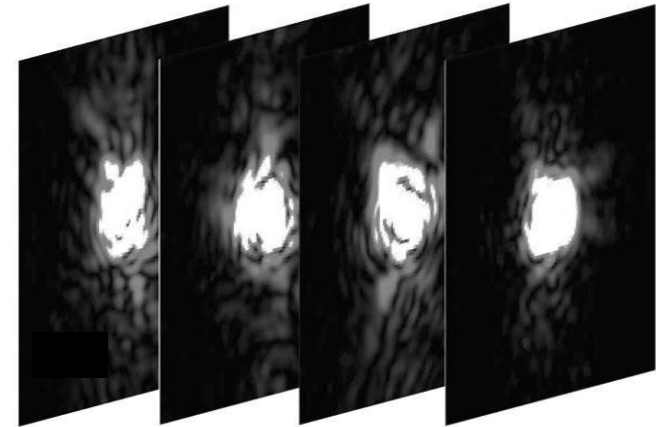


- fine inspection using phase retrieval algorithm in areas with defects

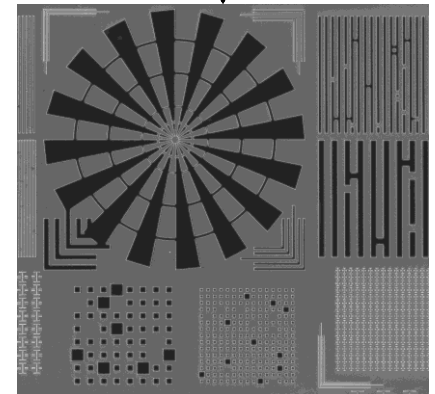
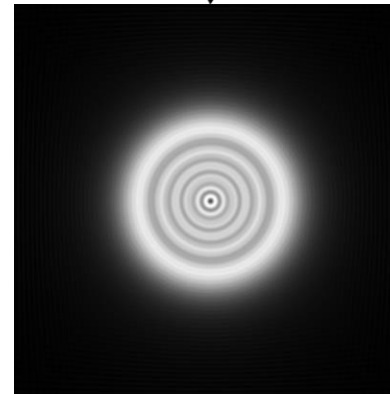


Ptychography

- no image formation optics
- resolution is not limited by optics
- large depth of focus
- scan across specimen to get multiple diffraction patterns with redundant data
- simultaneously recover incident illumination (Probe) and sample structure (Object)
- solve the phase problem

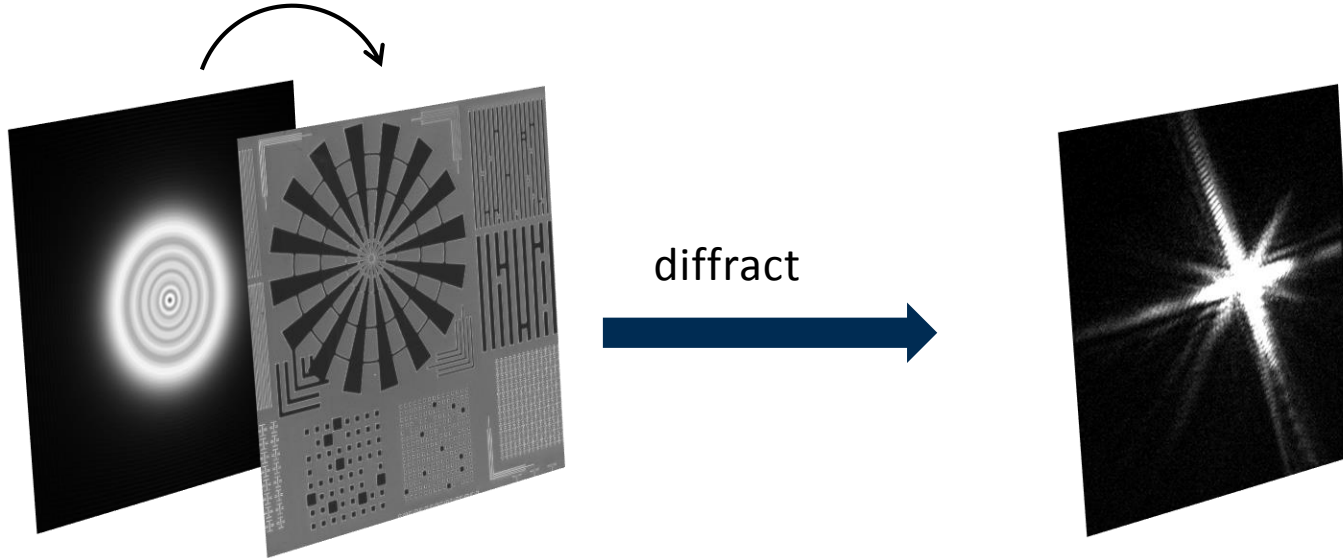


magic



Ptychography and the Difference Map

multiply



$$\psi_j(\mathbf{r}) = P(\mathbf{r} - \mathbf{r}_j)O(\mathbf{r})$$

constraints:

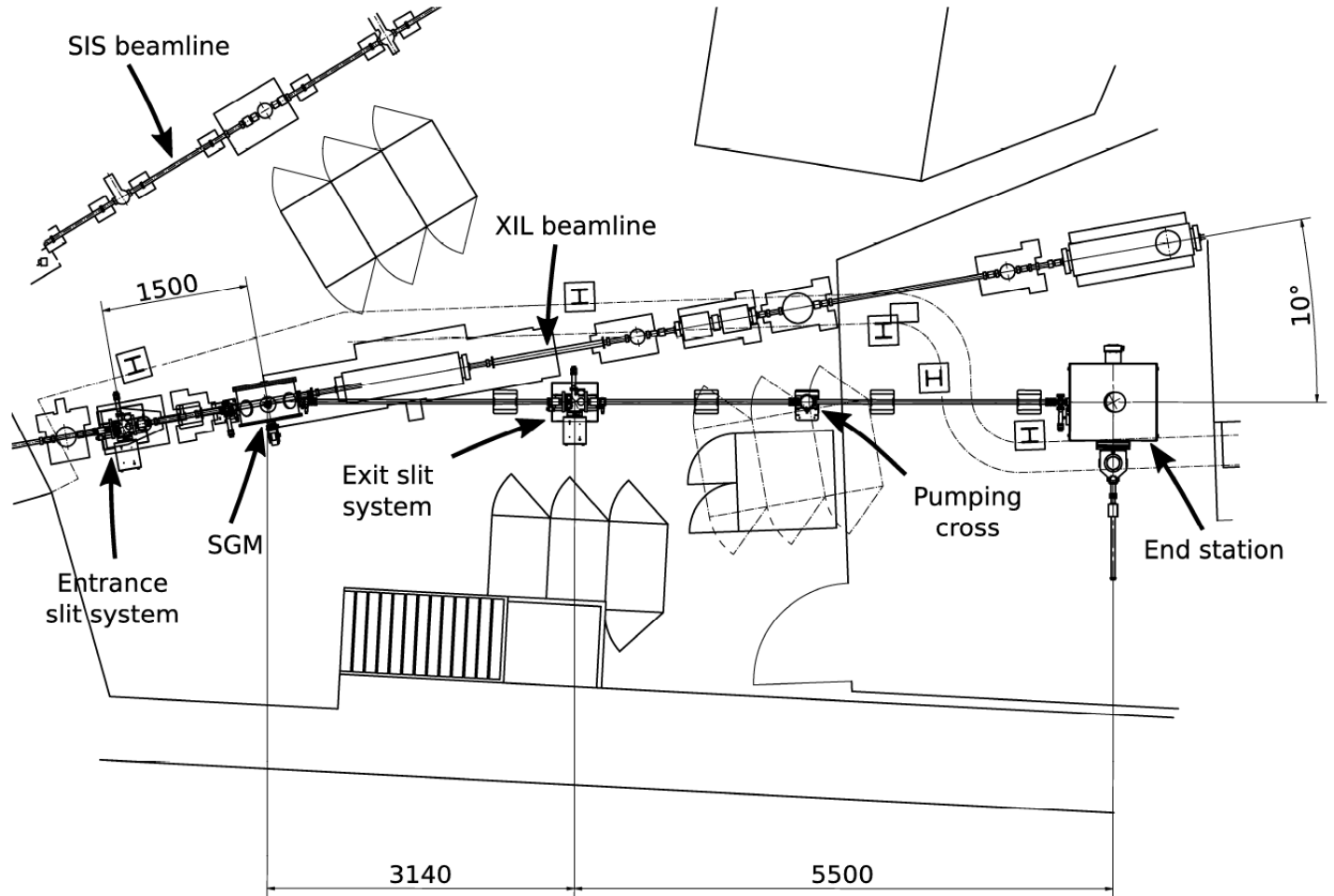
- i. reconstructed magnitude must match measured magnitude
- ii. data in overlapping areas must match

iteration:

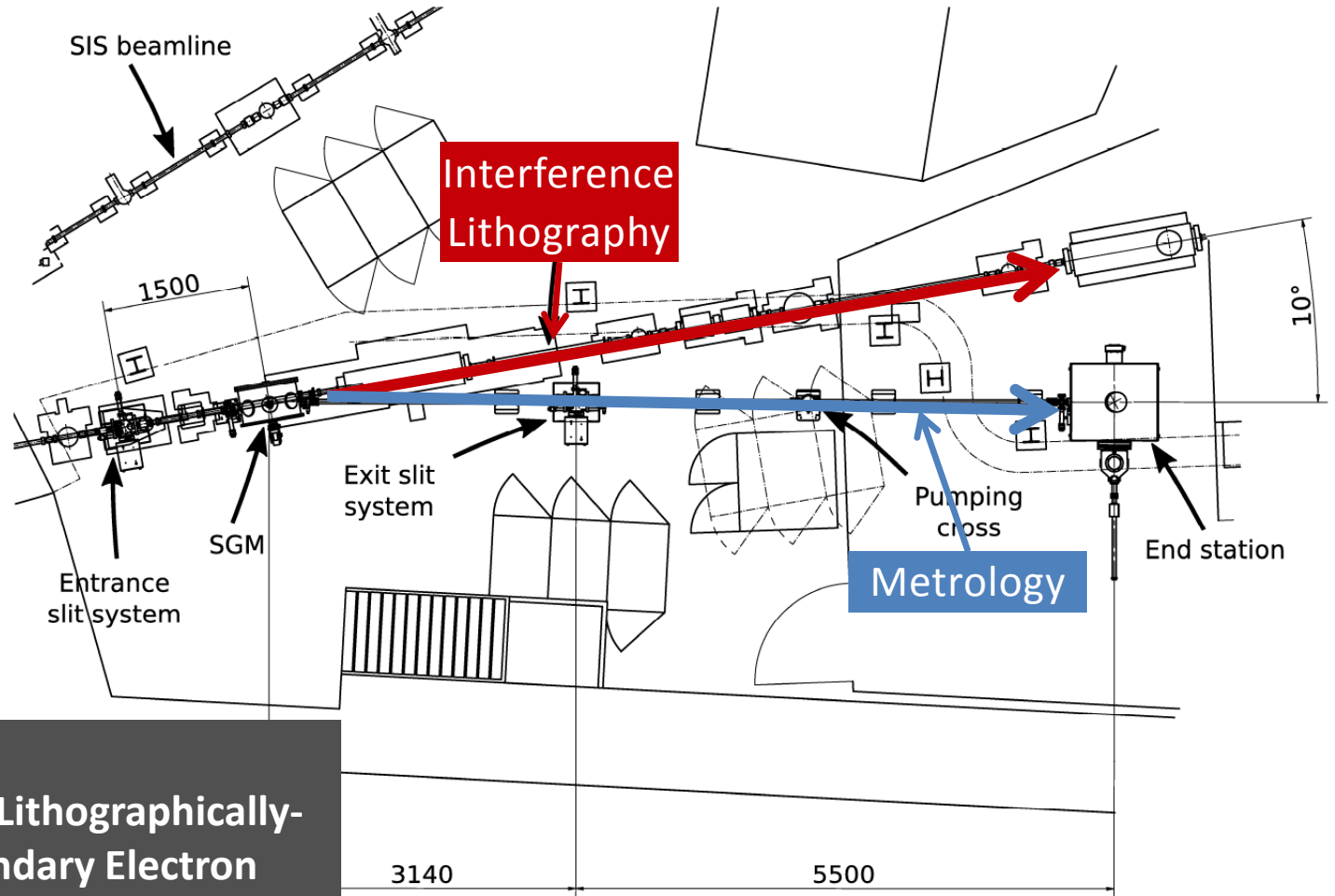
$$\hat{O}(\mathbf{r}) = \frac{\sum_j \hat{P}^*(\mathbf{r} - \mathbf{r}_j) \psi_j(\mathbf{r})}{\sum_j |\hat{P}(\mathbf{r} - \mathbf{r}_j)|^2}$$

$$\hat{P}(\mathbf{r}) = \frac{\sum_j \hat{O}^*(\mathbf{r} + \mathbf{r}_j) \psi_j(\mathbf{r} + \mathbf{r}_j)}{\sum_j |\hat{O}(\mathbf{r} + \mathbf{r}_j)|^2}.$$

RESCAN – Experimental Setup

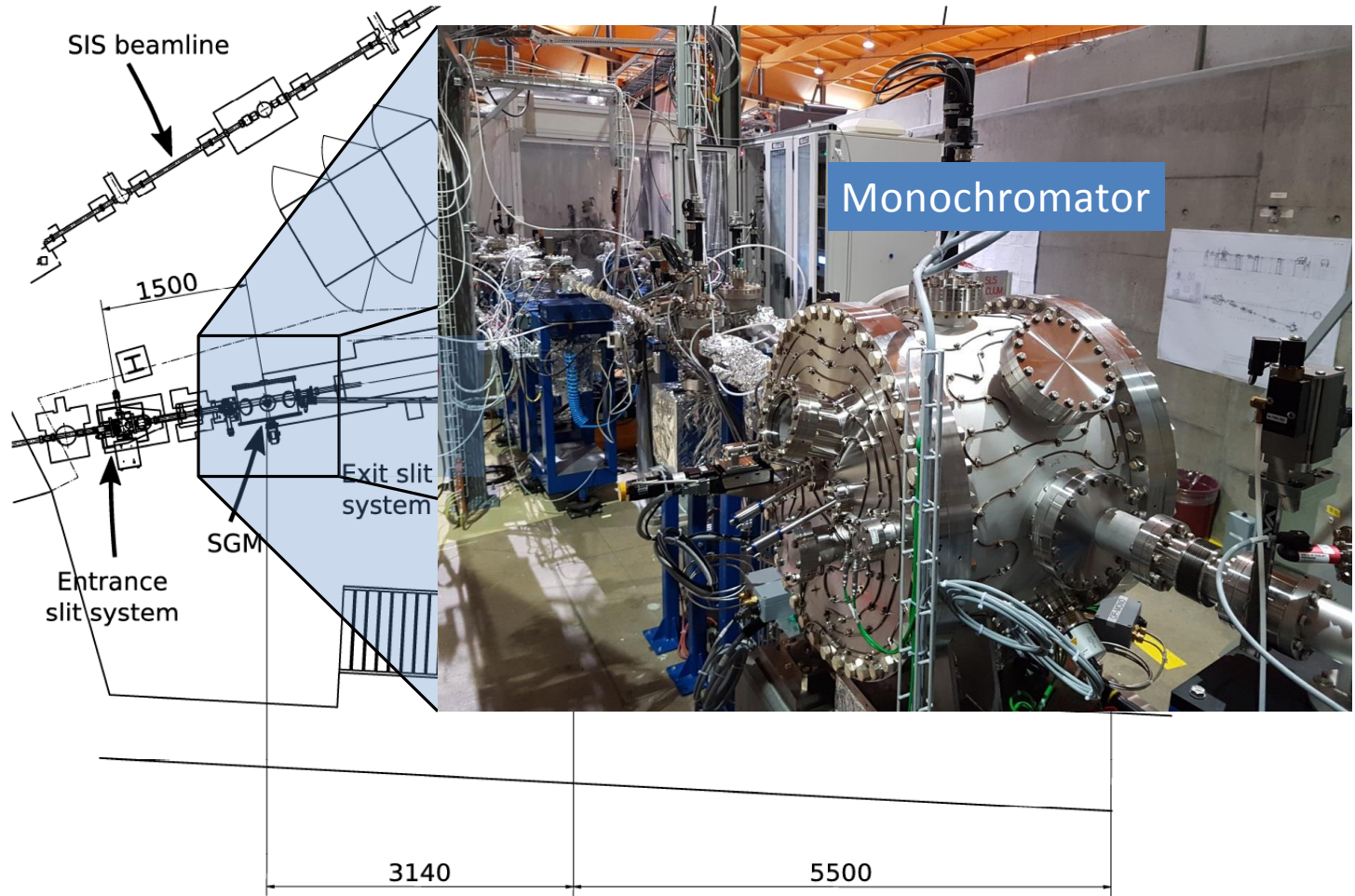


RESCAN – Experimental Setup

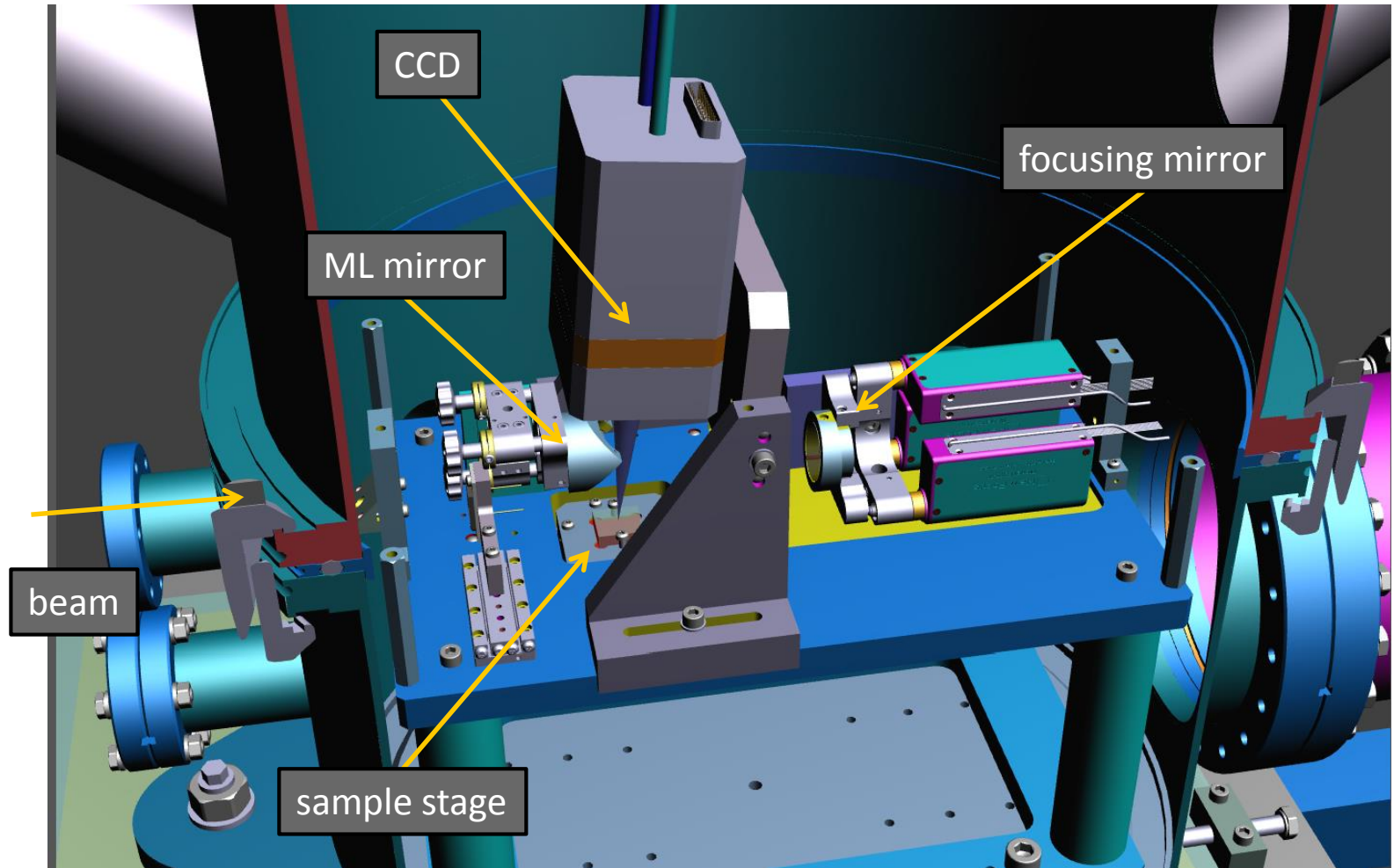


See also:
Estimation of Lithographically-relevant Secondary Electron Blur (P51)
Roberto Fallica

RESCAN – Experimental Setup

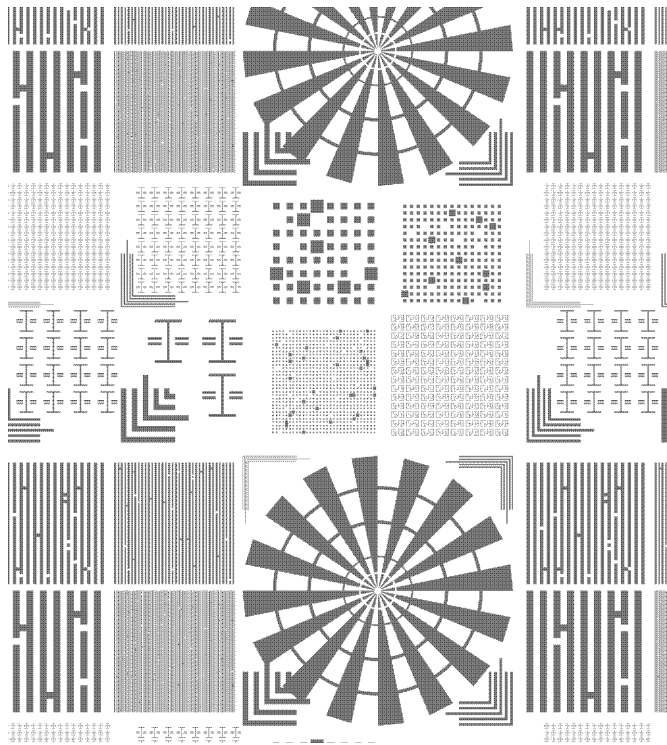


RESCAN – Experimental Setup



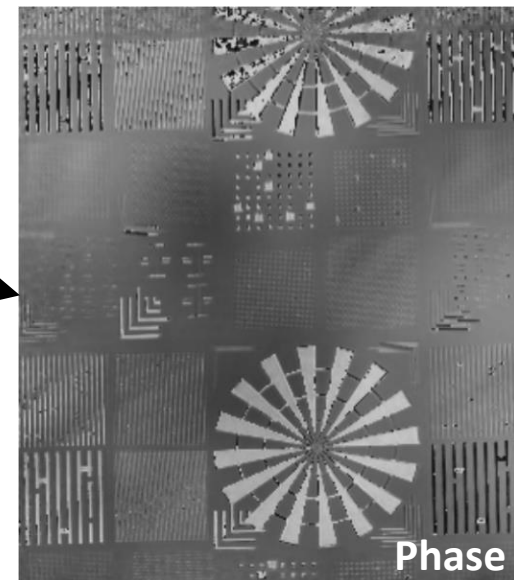
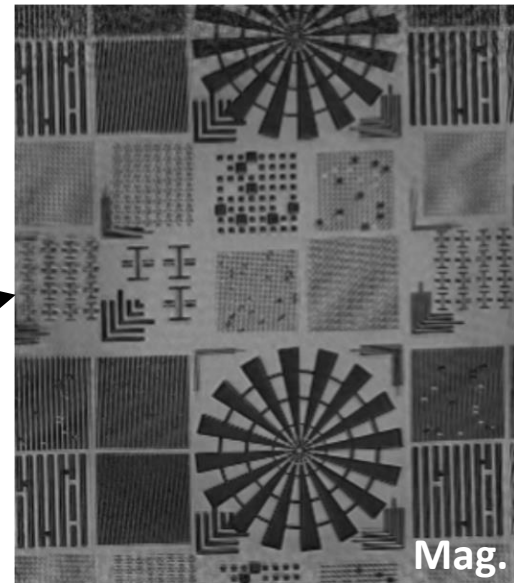
SCDI Reconstructed Image

mask pattern

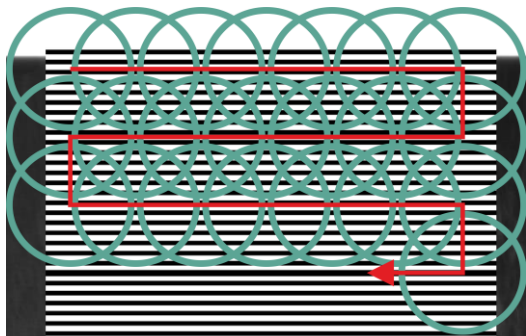


10 μm

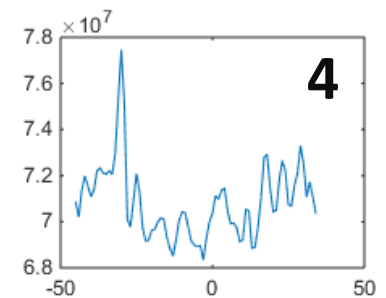
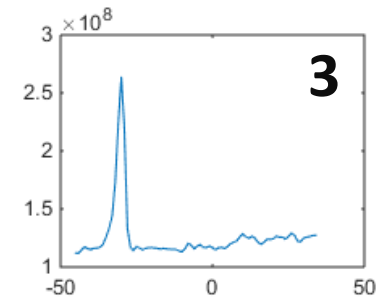
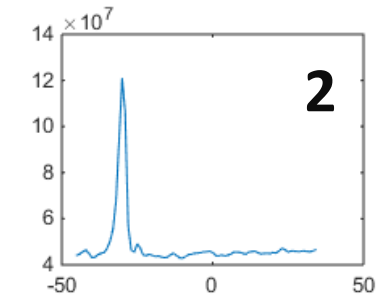
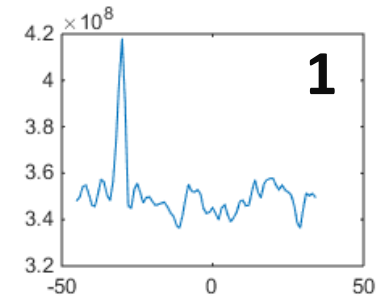
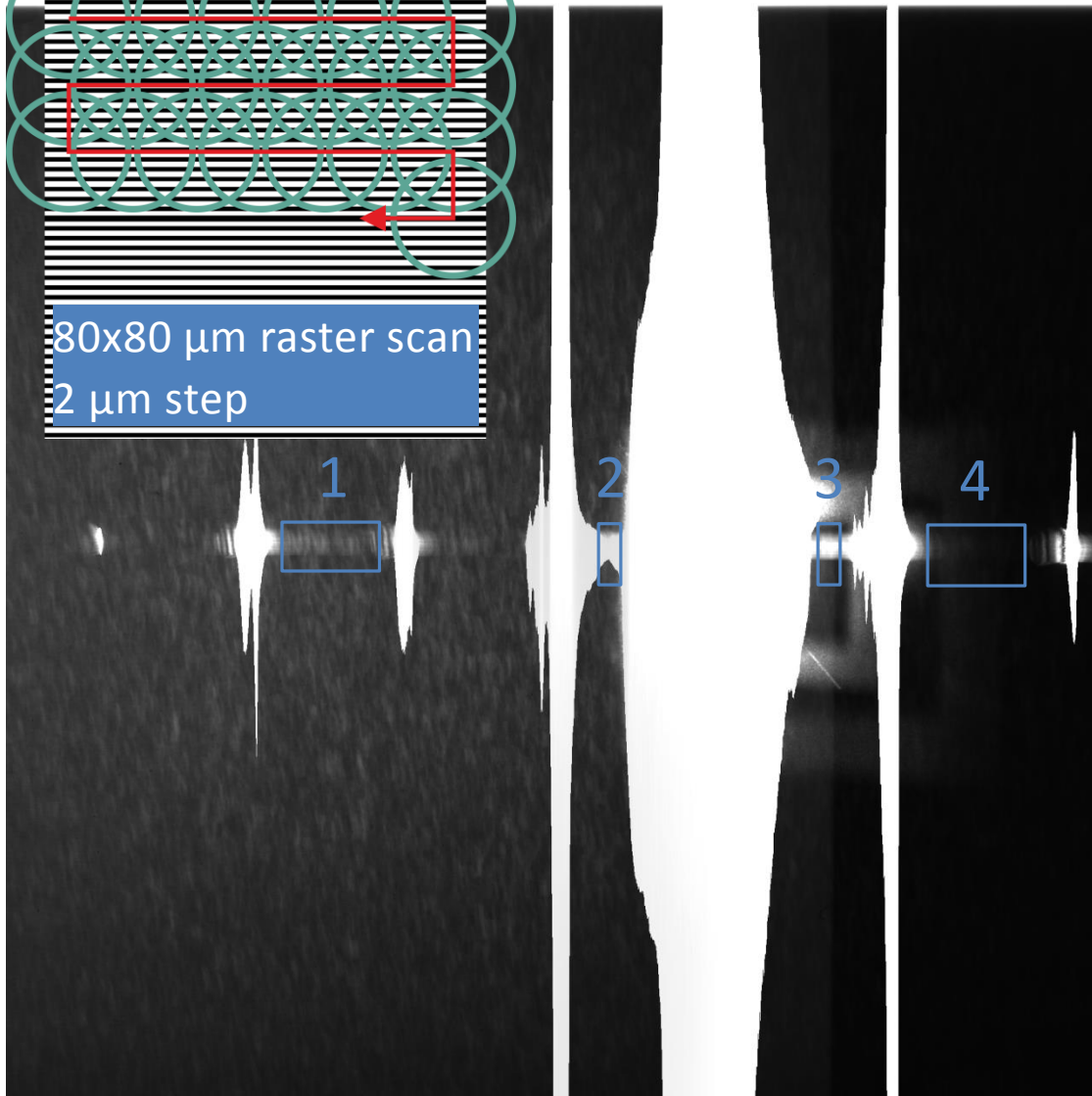
Reconstructed Sample



Detecting a 10 nm CD Error

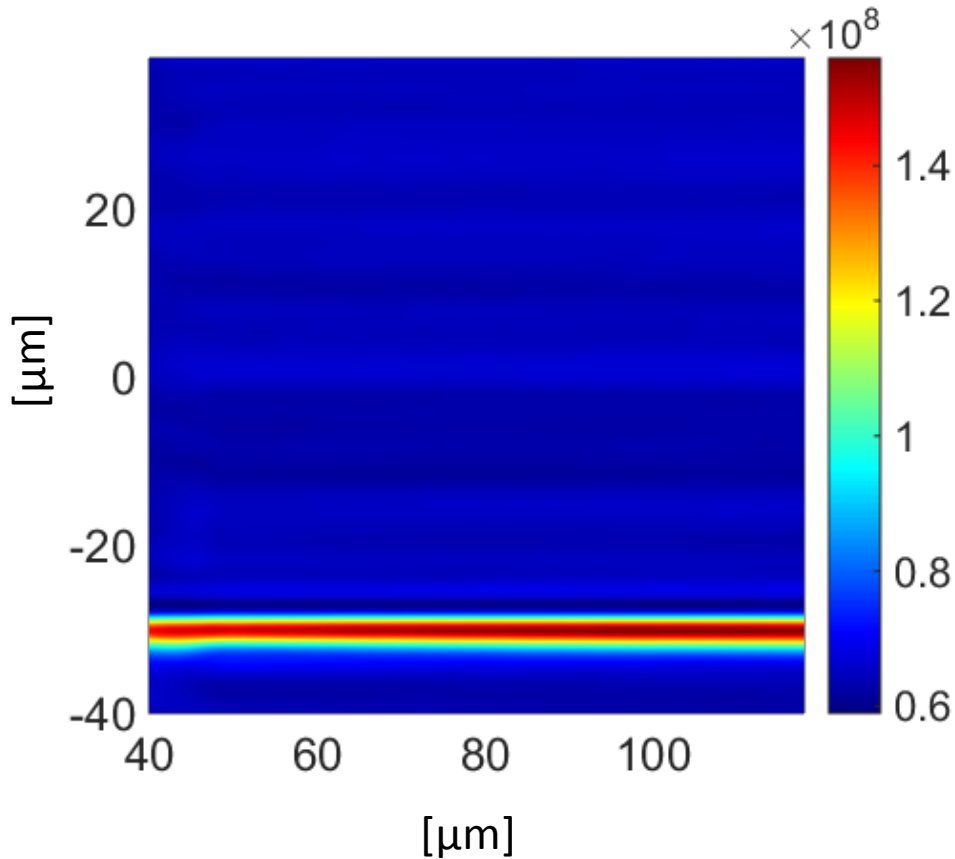


80x80 μm raster scan
2 μm step



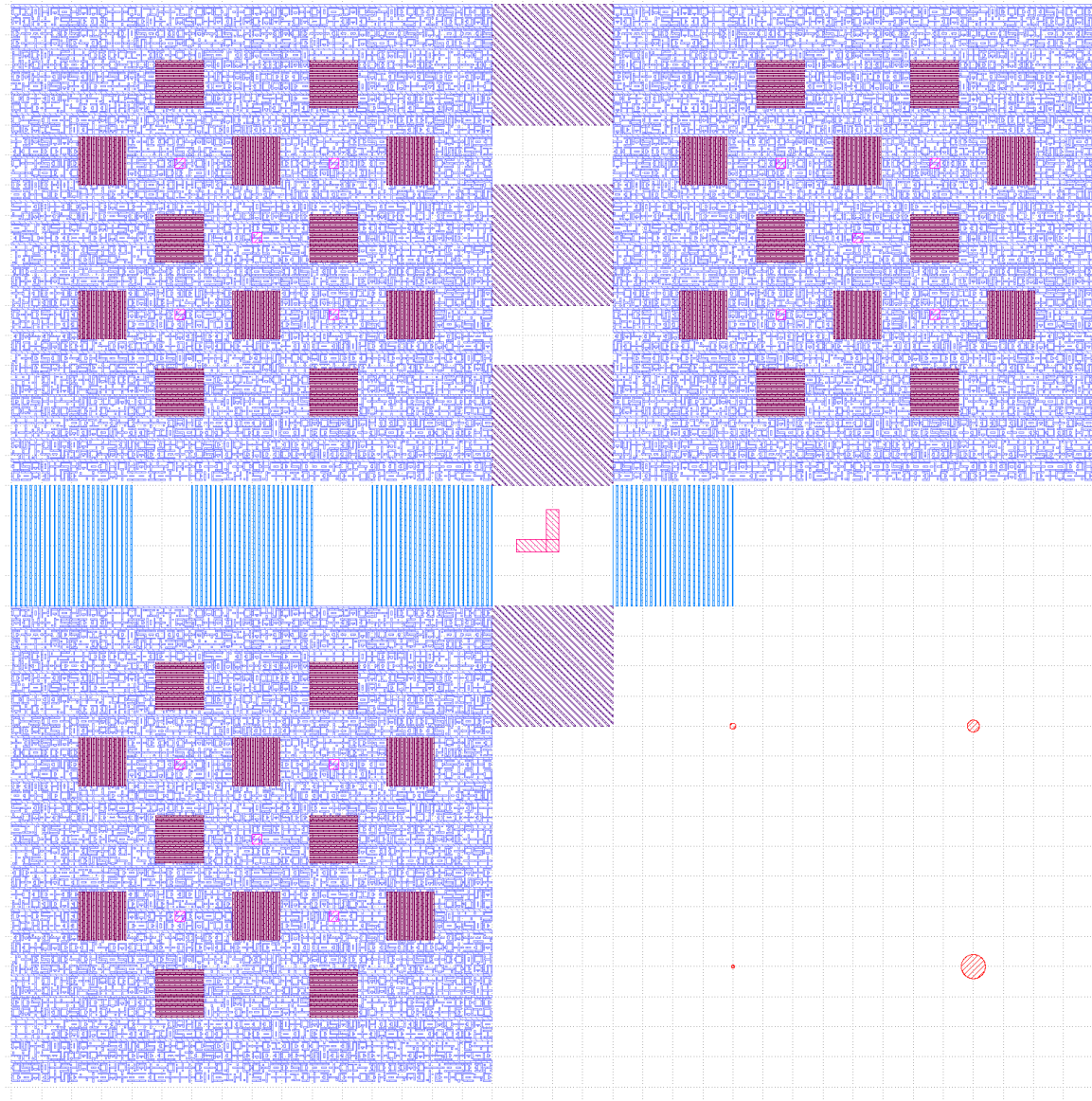
[μm]

Detecting a 10 nm CD Error



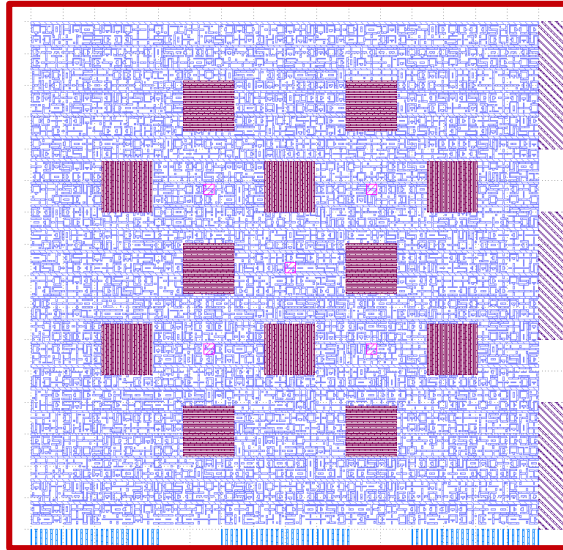
- 10 nm CD error in 100 nm hp grating can be detected
- location accuracy defined by spot size and scan step width
- subsequently, fine inspection would be done using SCDI

Defect Inspection with Non-Periodic Masks

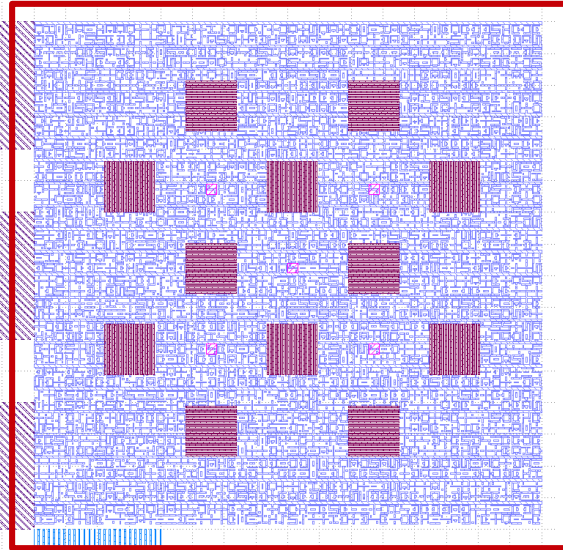


Defect Inspection with Non-Periodic Masks

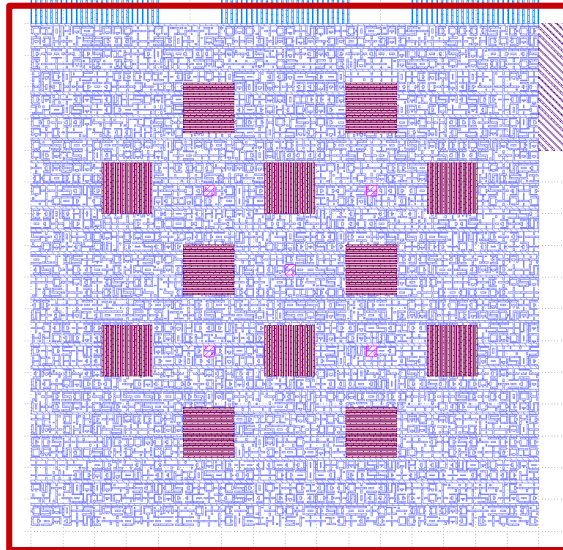
Reference



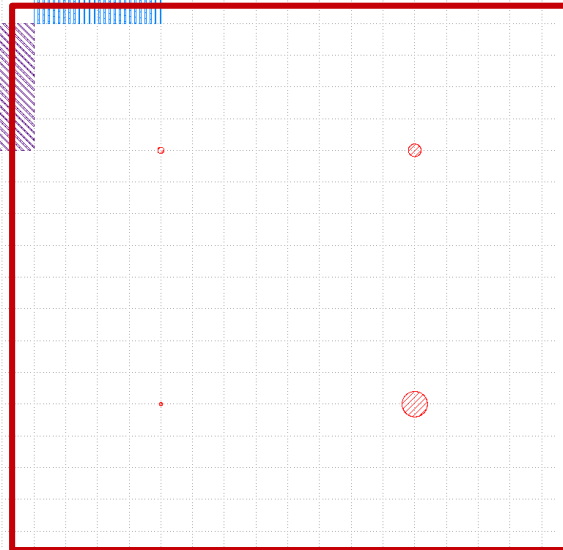
Extrusion



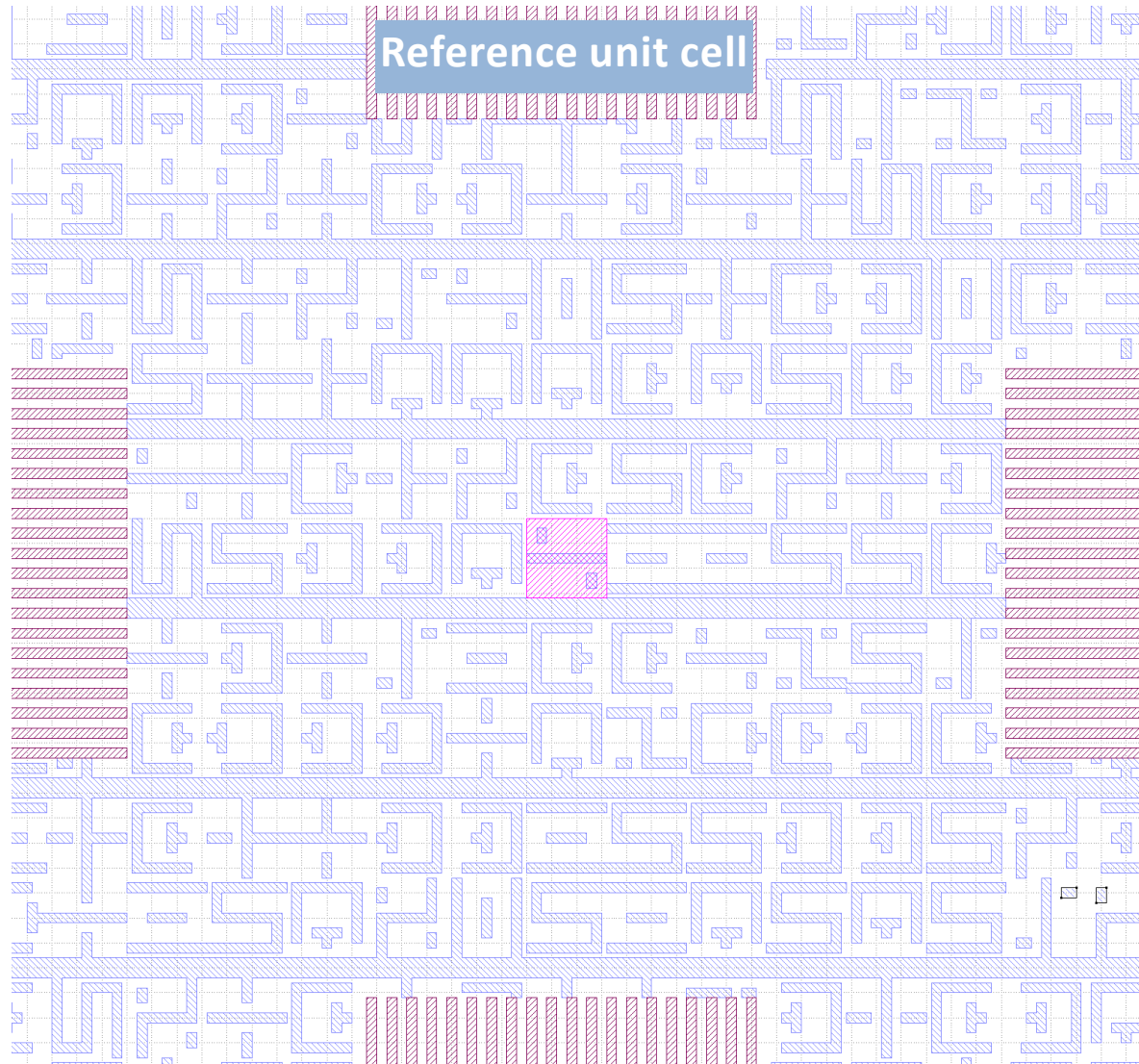
Gap



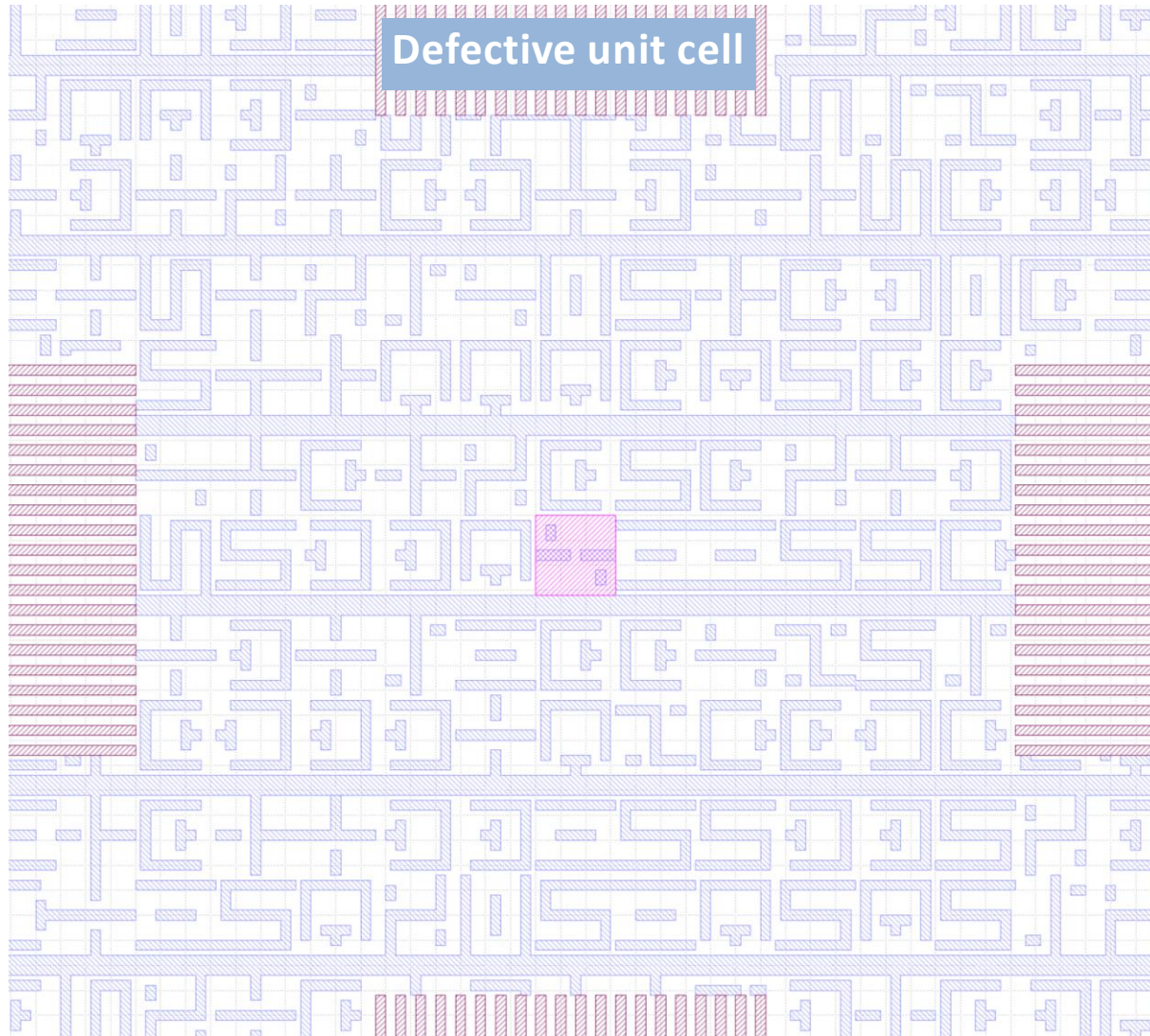
Calibration



Defect Inspection with Non-Periodic Masks

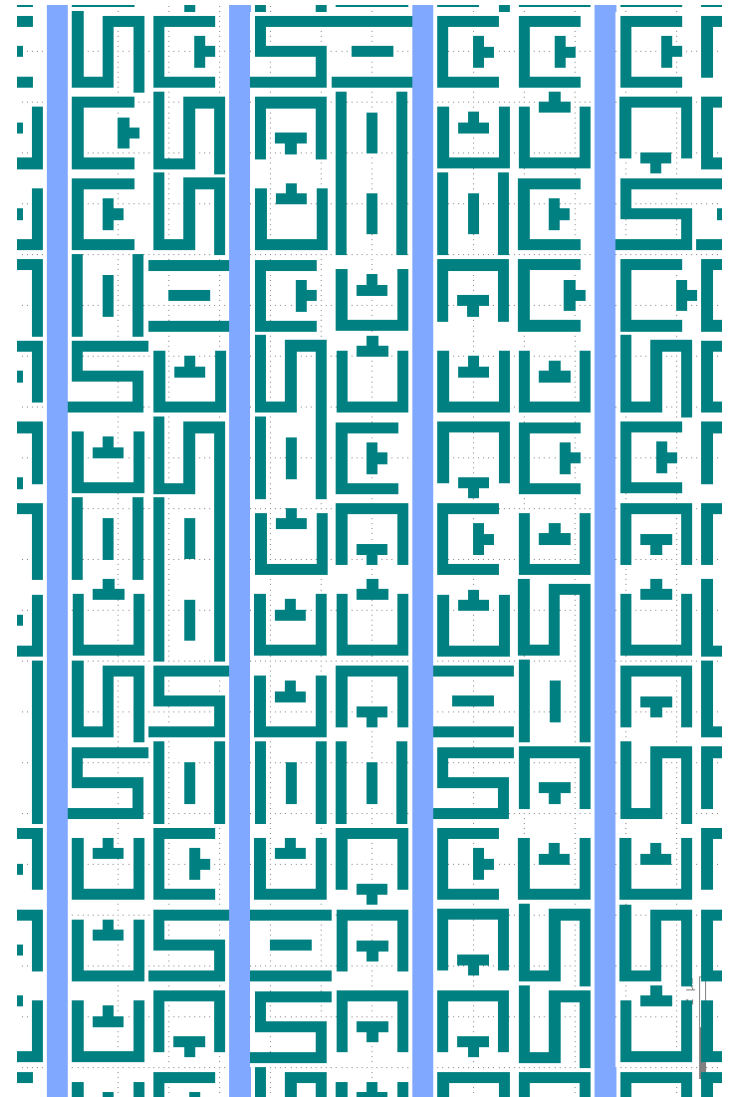


Defect Inspection with Non-Periodic Masks



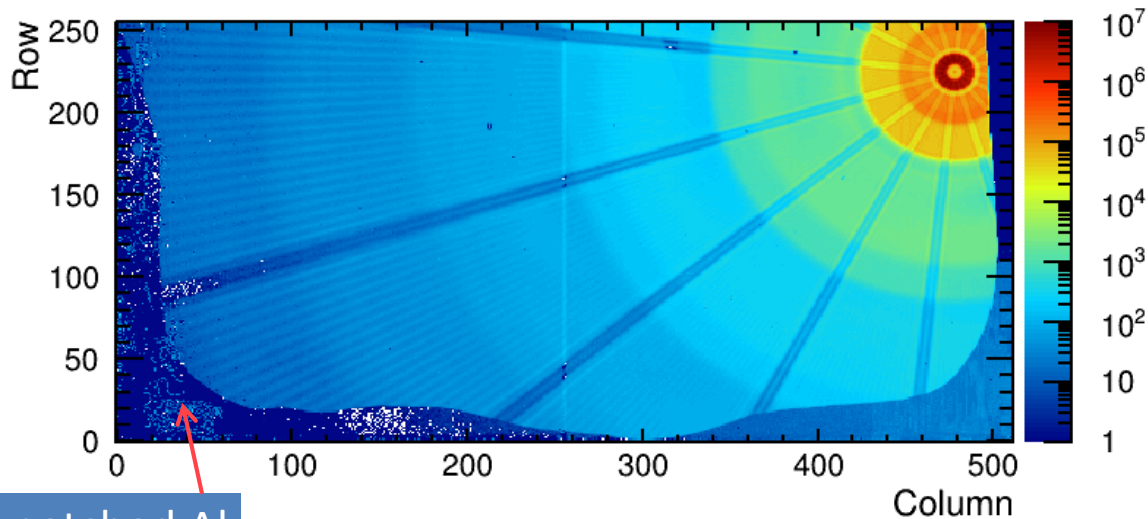
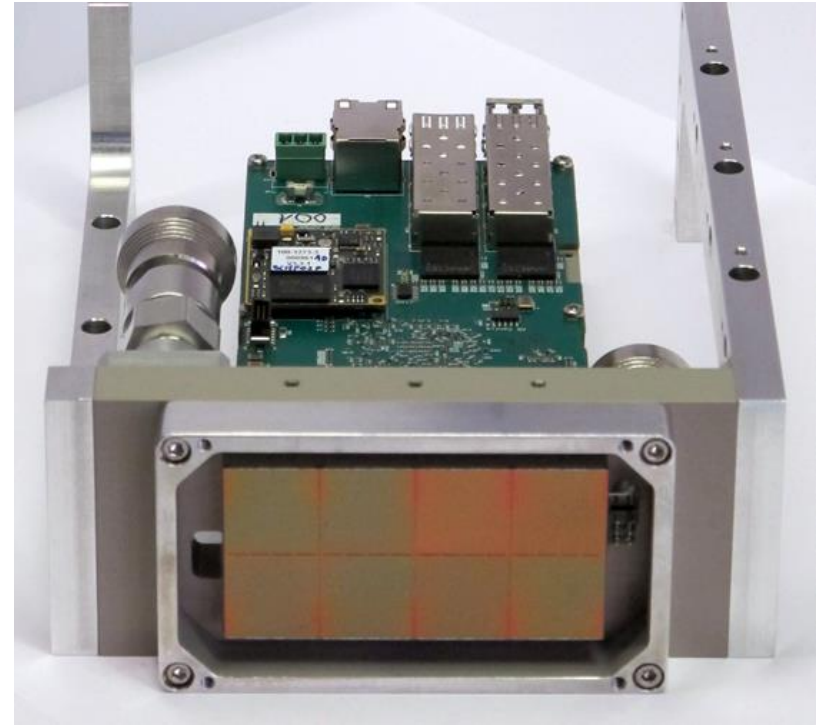
Defect Inspection with Non-Periodic Masks

- **sample**
 - HSQ on multilayer
- **method & challenges**
 - die-to-die inspection, reference pattern and several defects
 - SSCM is more challenging due to background (LER, noise), need higher contrast
 - alignment is important
 - SCDI remains the same

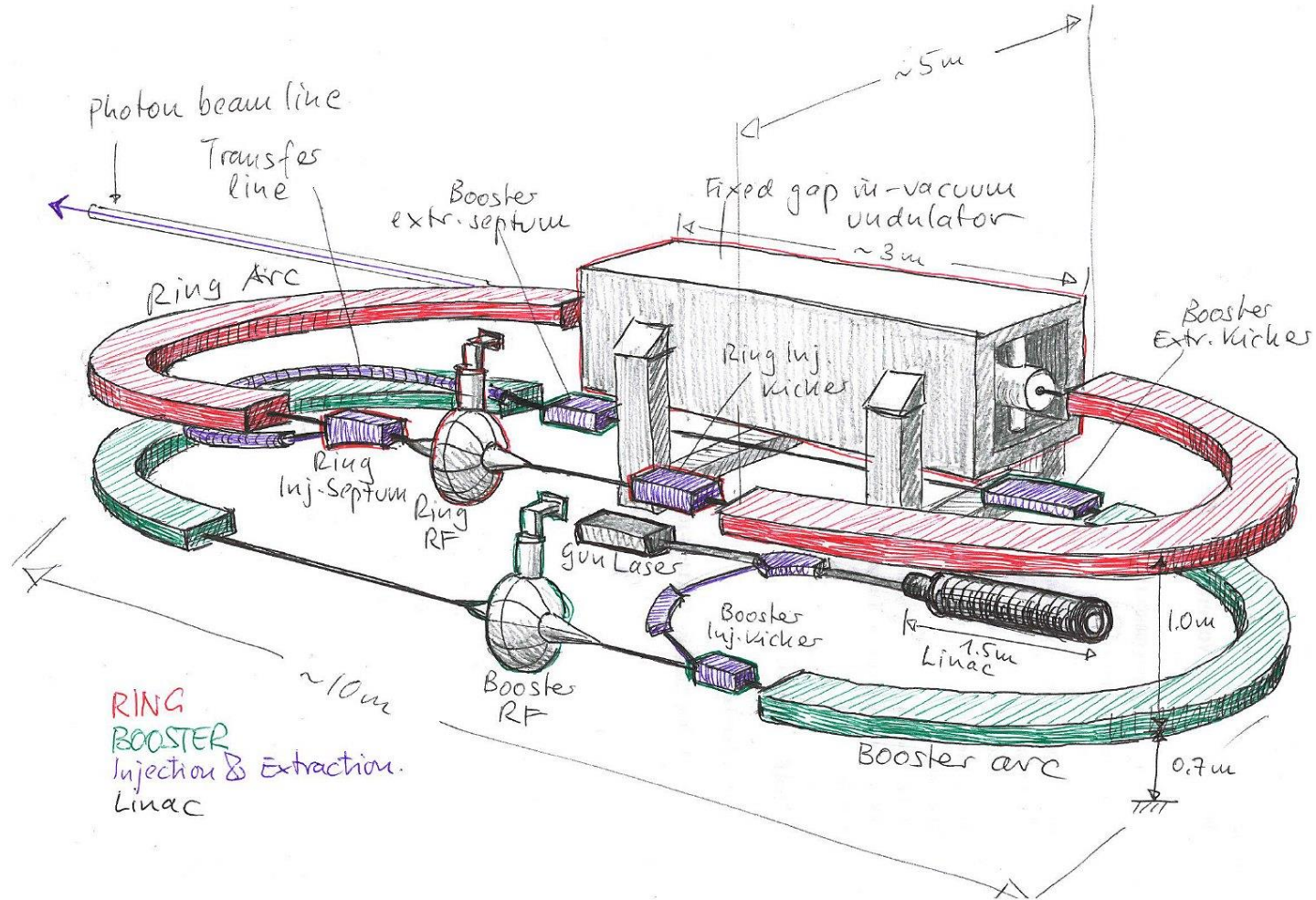


Fast Detector

- Hybrid CMOS detector: Jungfrau
 - 2 kHz acquisition rate
 - 10^6 photons/pixel dynamic range
 - 60% quantum efficiency
 - 75 μm pixel size
 - 50 e^- rms noise



Compact Source For Actinic Mask Inspection



Thank you all for listening

special thanks to the members of our group at PSI



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